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Vishay General Semiconductor

# High Current Density Surface Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.30 \text{ V}$  at  $I_F = 5 \text{ A}$ 



#### **LINKS TO ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS			
I <sub>F(AV)</sub>	10 A		
$V_{RRM}$	50 V		
I <sub>FSM</sub>	180 A		
V <sub>F</sub> at I <sub>F</sub> = 10 A	0.40 V		
T <sub>J</sub> max.	150 °C		
Package	SMPC (TO-277A)		
Circuit configuration	Single		

#### **FEATURES**

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>

#### **TYPICAL APPLICATIONS**

For use in low voltage high frequency DC/DC converters, freewheeling, and polarity protection applications.

#### **MECHANICAL DATA**

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V10PN50	UNIT	
Device marking code		10N5		
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	V	
Maximum average forward rectified current (fig. 1)	I <sub>F</sub> <sup>(1)</sup>	10	Α	
	I <sub>F</sub> <sup>(2)</sup>	5.3		
Maximum DC reverse voltage	$V_{DC}$	35	V	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	180	А	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-40 to +150	°C	

#### Notes

- (1) Mounted on 30 mm x 30 mm 2 oz. pad PCB
- (2) Free air, mounted on recommended copper pad area

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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 5 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.40	-	V
	I <sub>F</sub> = 10 A			0.47	0.55	
	I <sub>F</sub> = 5 A	T <sub>A</sub> = 125 °C		0.30	-	
	I <sub>F</sub> = 10 A			0.40	0.49	
Reverse current	V <sub>R</sub> = 50 V	T <sub>A</sub> = 25 °C	T <sub>A</sub> = 25 °C	50	1500	μA
	$v_R = 50 \text{ V}$	$T_A = 25 ^{\circ}\text{C}$ $T_A = 125 ^{\circ}\text{C}$	IR (−)	32	85	mA

#### **Notes**

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

 $^{(2)}$  Pulse test: Pulse width  $\leq 5 \text{ ms}$ 

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	V10PN50	UNIT		
Typical thermal registence	R <sub>0</sub> JA (1) (2)	70	°C/W	
Typical thermal resistance	R <sub>0JM</sub> (3)	4		

#### Notes

- $^{(1)}$  Free air, mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  junction-to-ambient
- The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$
- (3) Mounted on 30 mm x 30 mm 2 oz. pad PCB; thermal resistance R<sub>6JM</sub> junction-to-mount measured at cathode side

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V10PN50-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel	
V10PN50-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel	

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## **RATINGS AND CHARACTERISTICS CURVES** (T<sub>A</sub> = 25 °C unless otherwise noted)

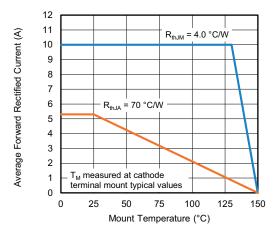
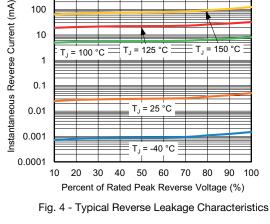


Fig. 1 - Maximum Forward Current Derating Curve (D = Duty Cycle = 0.5)



1000

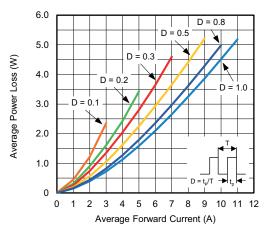


Fig. 2 - Forward Power Loss Characteristics

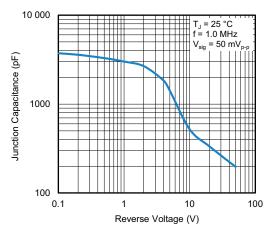


Fig. 5 - Typical Junction Capacitance

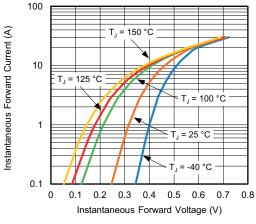


Fig. 3 - Typical Instantaneous Forward Characteristics

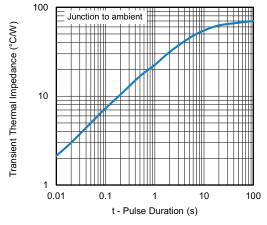


Fig. 6 - Typical Transient Thermal Impedance

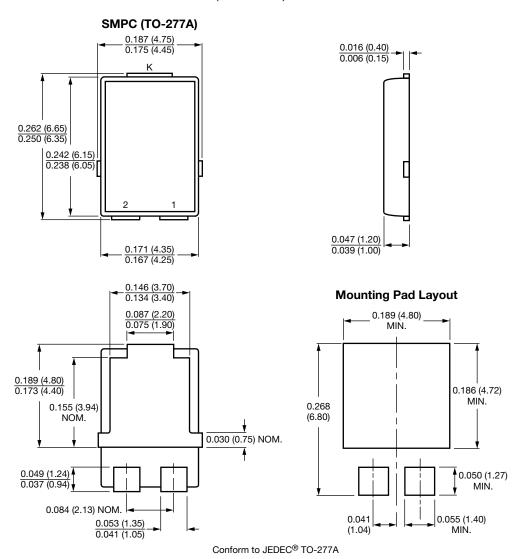
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### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)



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